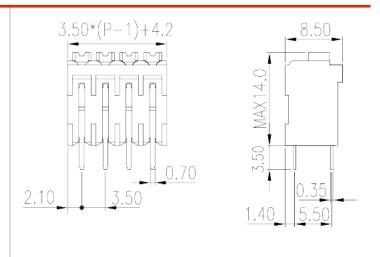


0138-50XXL

PCB > PCB :2025-11-05 :V1





Pitch: 3.50mm, 300V, 12A

	PCB Terminal Blocks, Push-in Design
	PCB Terminal Blocks
(mm)	3.50
	Black (default)
	Push in design
	Without
	Reflow Soldering (Temperature condition according to standard IPC/JEDEC J-STD-020E)
(mm)	3.50*(P-1)+4.2
(mm)	8.5
(mm)	14
(x) (mm)	0.35x0.7
PCB (mm)	1~1.1
()	02P~24P
	Single level

HIGH-TEMPERATURE PLASTICS

	IIIa
UL 94	VO
	500M at DC 500V
	COPPER ALLOY
	Tin PLATED
MSL	1
-IEC	
(V)	160
(A)	17.5
(II/2)(V)	320
(III/2)(V)	160
(III/3)(V)	160
(II/2)(KV)	2.5
(III/2)(KV)	2.5
(III/3)(KV)	2.5
(mm ²)	0.14
(mm ²)	1.5
(mm ²)	0.14
(mm ²)	1.5
(mm ²)	0.25
(mm ²)	1
(mm ²)	0.25
(mm²)	0.75
(Blade thickness x Width)(mm)	0.4x2.5
	8~9
-UL	
(UL/CUL Group B)(V)	300
(UL/CUL Group B)(A)	12
(UL/CUL Group D)(V)	300
(UL/CUL Group D)(A)	12

UL/CUL	AWG	28
UL/CUL	AWG	16
UL/CUL	AWG	28
UL/CUL AWG		16
&		
가 (YES or NO)	r NO)	YES
		120
		-40
JL		
(Group B)	(AWG)	28~16
(Group B)(V)		300
(Group B)(A)		12
(Group D)(AWG)		28~16
(Group D)(V)		300
(Group D)(A)		12
CUL		
(Group B)(AWG)		28~16
(Group B)(V)		300
(Group B)(A)		12
(Group D)(AWG)		28~16
(Group D)(V)		300
(Group D)(A)		12
/DE		
(mm ²)		0.2~1.5
(V)		160
(∨)		17.5

